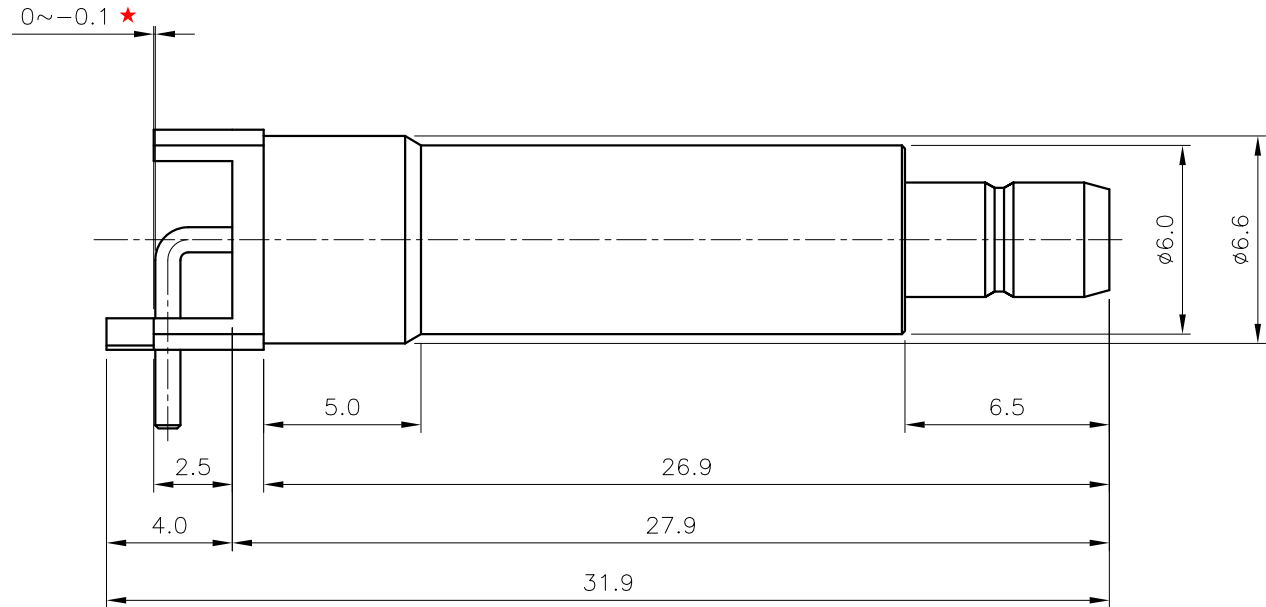
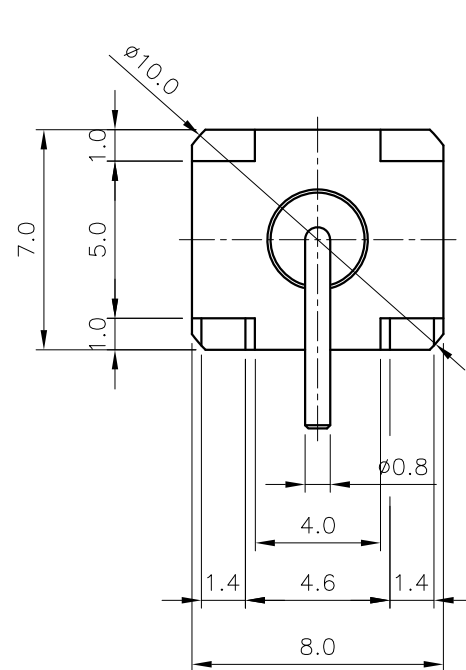


* 상대물 삽.이탈력 SPEC
삽입력 : 2~4Kgf
이탈력 : 5~8Kgf

REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.H.KIM		2023.06.07.



4	INSULATOR	1	TEFLON		DIN03363-N/1
3	INSULATOR	1	TEFLON		DIN03362-N/1
2	CONTACT	1	MBsBD C3604BD-F	Gold 0.4μm Plate	DCT04388-5/2
1	BODY	1	MBsBD C3604BD-F	Gold Plate (하지 Nickel 5μm이상)	DBD04908-5/2
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.2	DATE 2023. 06. 07.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle ±1°	APPROVED BY			
MATERIAL _____		CHECKED BY			TITLE SMB50 PCB JS-4R
		DRAWN BY S.H.KIM			
FINISH _____		SCALE 5/1	UNIT mm		A4
					REVISION I R SHEET 1 of 1